

# SN74CBTLV162292

## LOW-VOLTAGE 12-BIT 1-OF-2 FET MULTIPLEXER/DEMULTIPLEXER WITH INTERNAL PULLDOWN RESISTORS

SCDS056C – MARCH 1998 – REVISED NOVEMBER 1998

- 4- $\Omega$  Switch Connection Between Two Ports
- Isolation Under Power-Off Conditions
- Make-Before-Break Feature
- Internal 500- $\Omega$  Pulldown Resistors to Ground
- A-Port Inputs/Outputs Have Equivalent 25- $\Omega$  Series Resistors, So No External Resistors Are Required
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and 300-mil Shrink Small-Outline (DL) Packages

NOTE: For order entry:

The DGG package is abbreviated to G, and  
the DGV package is abbreviated to V.

### description

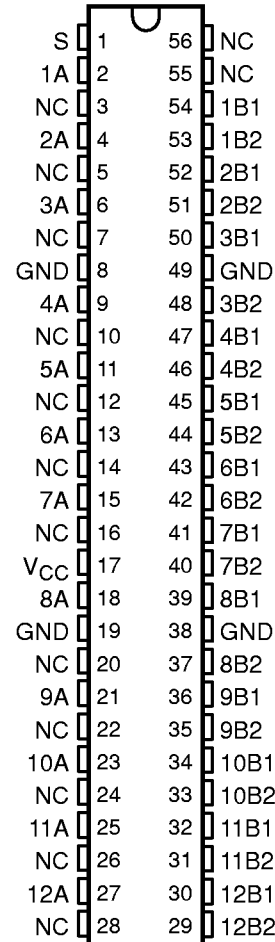
The SN74CBTLV162292 is a 12-bit 1-of-2 high-speed FET multiplexer/demultiplexer. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

When the select (S) input is low, port A is connected to port B1 and  $R_{INT}$  is connected to port B2. When S is high, port A is connected to port B2 and  $R_{INT}$  is connected to port B1.

The A-port inputs/outputs include equivalent 25- $\Omega$  series resistors to reduce overshoot and undershoot.

The SN74CBTLV162292 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE

INPUT S	FUNCTION
L	A port = B1 port $R_{INT}$ = B2 port
H	A port = B2 port $R_{INT}$ = B1 port



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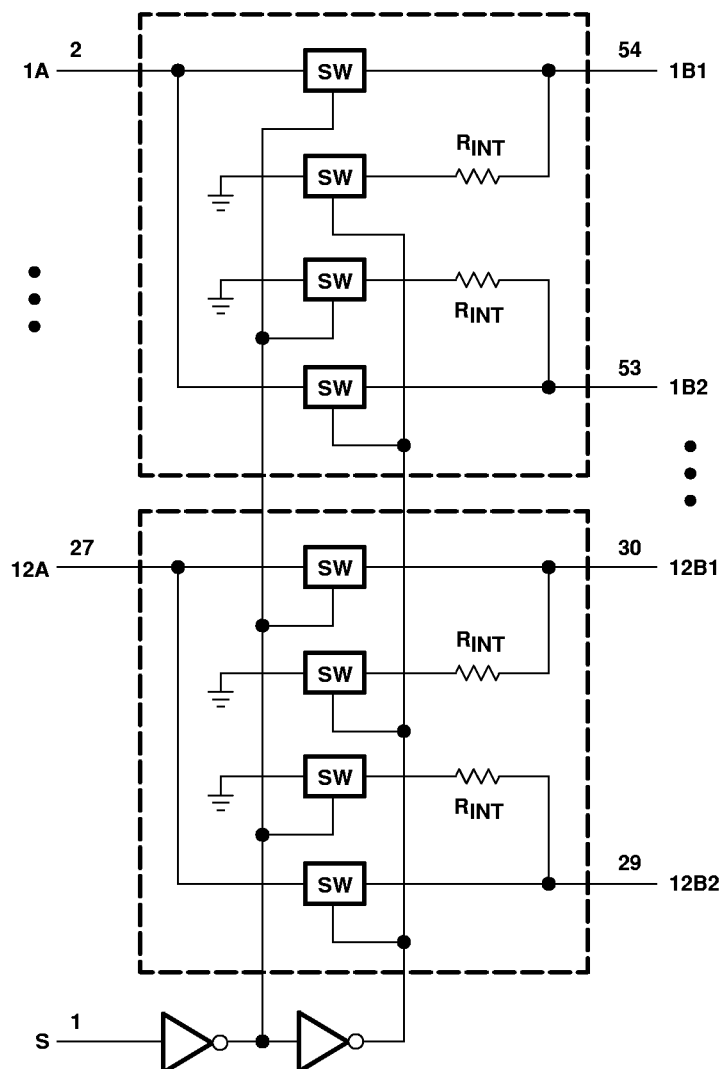
PRODUCT PREVIEW

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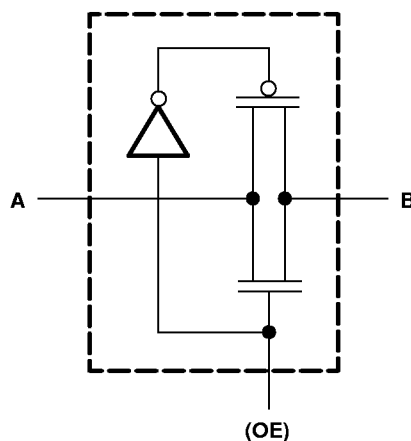
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logic diagram (positive logic)



simplified schematic, each FET switch





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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	
$t_{pd}^{\dagger}$	A or B	B or A					ns
$t_{en}$	S	A or B					ns
$t_{dis}$	S	A or B					ns

$\dagger$  The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

switching characteristics,  $T_A = 0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$  (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
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switching characteristics,  $T_A = 0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$  (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	DESCRIPTION	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
		MIN	MAX	MIN	MAX	
$t_{mbb}^{\ddagger}$	Make-before-break time					ns

$\ddagger$  The make-before-break time is the time interval between make and break, during the transition from one selected port to the other.

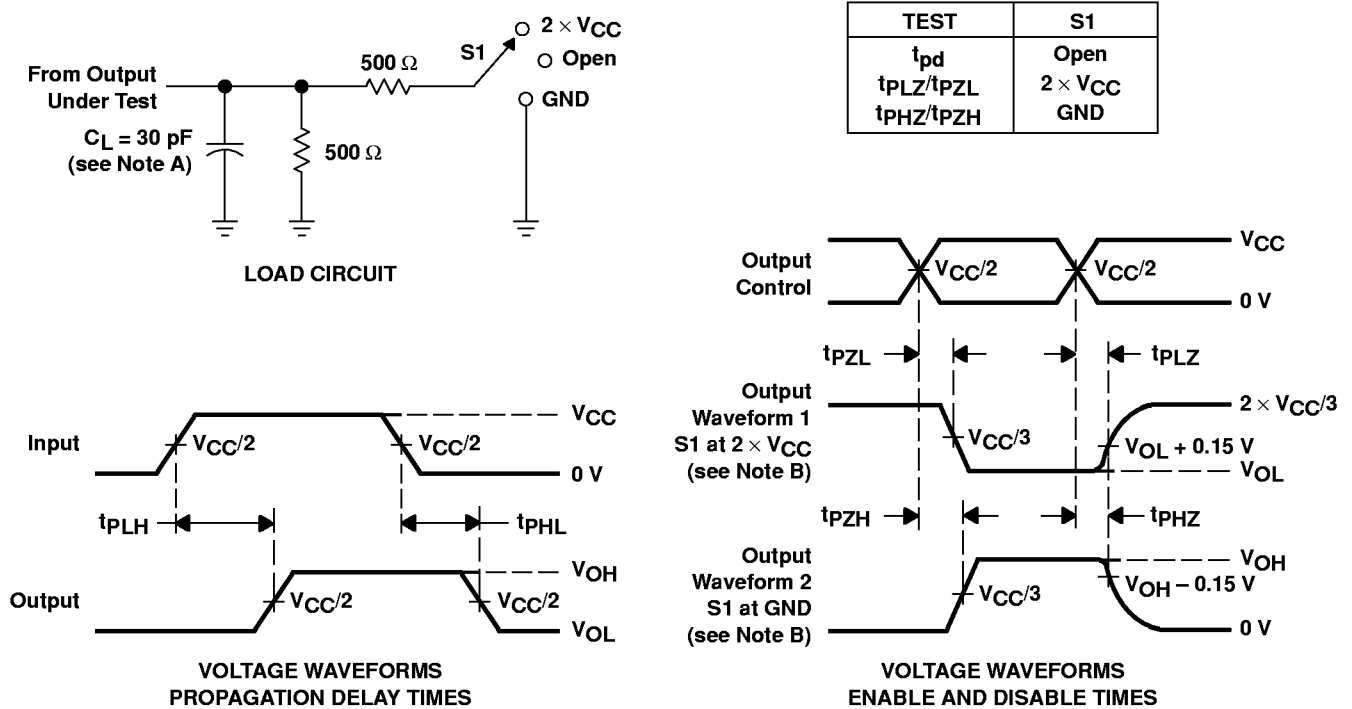
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### PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2 \text{ ns}$ ,  $t_f \leq 2 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

**Figure 1. Load Circuit and Voltage Waveforms**

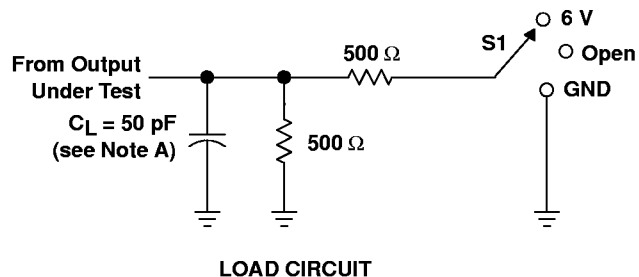
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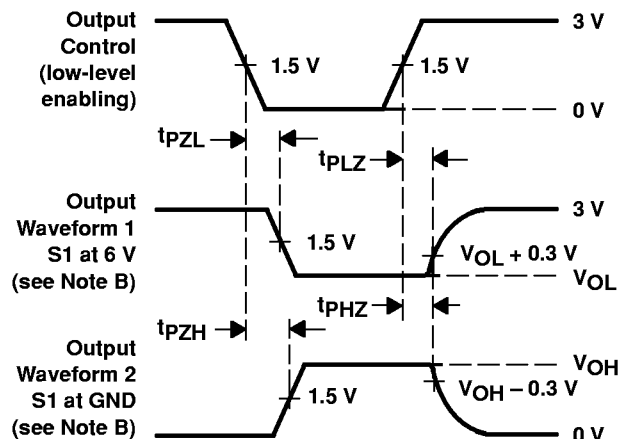
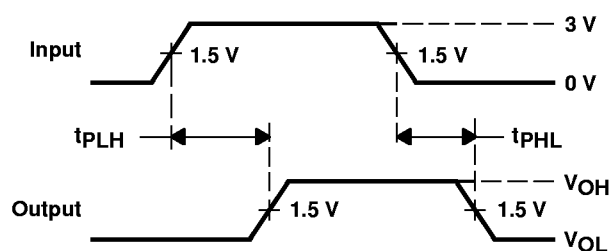
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## PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$$



TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 2. Load Circuit and Voltage Waveforms

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